

[10191/2251]

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

Inventor(s) : Richard SPITZ et al.  
Serial No. : To Be Assigned  
Filed : Herewith  
For : ARRANGEMENT HAVING P-DOPED AND N-DOPED  
SEMICONDUCTOR LAYERS, AND METHOD FOR THE  
MANUFACTURE THEREOF  
Examiner : To Be Assigned  
Art Unit : To Be Assigned

#6/A  
4/3/03  
Jum.

Assistant Commissioner for Patents  
Washington, D.C. 20231

**PRELIMINARY AMENDMENT AND  
37 C.F.R. § 1.125 SUBSTITUTE SPECIFICATION STATEMENT**

S I R:

Kindly amend the above-captioned application before examination, as  
set forth below.

**IN THE SPECIFICATION AND ABSTRACT:**

In accordance with 37 C.F.R. § 1.121(b)(3), a Substitute Specification  
(including the Abstract, but without claims) accompanies this response. It is  
respectfully requested that the Substitute Specification (including Abstract) be  
entered to replace the Specification of record.

**IN THE CLAIMS:**

On the first page of the claims, first line, change "What is claimed is:"  
to WHAT IS CLAIMED IS:--.

Please cancel, without prejudice, claims 1 to 23 in the underlying PCT  
application.

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